

A O 6804A 20V Dual N-Channel MOSFET

General Description

The AO6804A uses advanced trench technology to provide excellent $R_{\text{DS(ON)}}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a load switch applications.

Product Summary

 $V_{DS} = 20V$

 $I_D = 5.0A$ $(V_{GS} = 4.5V)$

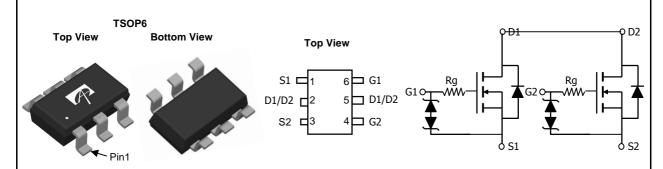
 $R_{DS(ON)} < 28m\Omega \ (V_{GS} = 4.5V)$

 $R_{DS(ON)} < 30 m\Omega \ (V_{GS} = 4.0 V)$

 $R_{DS(ON)} < 34 m\Omega \; (V_{GS} = 3.1 V)$

 $R_{DS(ON)} < 39 m\Omega \ (V_{GS} = 2.5 V)$





Absolute Maximum Ratings T _A =25℃ unless otherwise noted							
Parameter		Symbol	Maximum	Units			
Drain-Source Voltage		V_{DS}	20	V			
Gate-Source Voltage		V_{GS}	±12	V			
Continuous Drain	T _A =25℃		5				
Current ^A	T _A =70℃	I _D	4	Α			
Pulsed Drain Current ^B		I _{DM}	25	1			
Power Dissipation ^A	T _A =25℃	Ь	1.3	W			
	T _A =70℃	-P _D	0.8]			
Junction and Storage Temperature Range		T _J , T _{STG}	-55 to 150	C			

Thermal Characteristics								
Parameter	Symbol	Тур	Max	Units				
Maximum Junction-to-Ambient A	t ≤ 10s R _{θJA}		76	95	€\M			
Maximum Junction-to-Ambient A	Steady State	IN _θ JA	118	150	€\M			
Maximum Junction-to-Lead ^C	Steady State	$R_{ hetaJL}$	54	68	℃/W			



Electrical Characteristics (T_J=25℃ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Тур	Max	Units	
STATIC F	PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	20			V	
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 20V, V_{GS} = 0V$			1		
		T _J = 55℃			5	μΑ	
I _{GSS}	Gate-Body leakage current	$V_{DS} = 0V$, $V_{GS} = \pm 10V$			±10	υΑ	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS} I_D = 250\mu A$	0.5	0.7	1	V	
I _{D(ON)}	On state drain current	$V_{GS} = 4.5V, V_{DS} = 5V$	25			Α	
		$V_{GS} = 4.5V, I_D = 5.0A$	18	23	28	mΩ	
		T _J =125℃	26	33	40	11152	
	Static Drain-Source On-Resistance	$V_{GS} = 4.0V, I_D = 4.5A$	19	24	30	mΩ	
		$V_{GS} = 3.1V, I_D = 4.5A$	20	27	34	mΩ	
		$V_{GS} = 2.5V, I_D = 4.0A$	21	30	39	mΩ	
g _{FS}	Forward Transconductance	$V_{DS} = 5V, I_{D} = 5.0A$		18		S	
V_{SD}	Diode Forward Voltage	$I_S = 1A, V_{GS} = 0V$		0.65	1	V	
I _S	Maximum Body-Diode Continuous Current				1.3	Α	
DYNAMIC	PARAMETERS						
C _{iss}	Input Capacitance			180	225	pF	
C _{oss}	Output Capacitance	V _{GS} =0V, V _{DS} =10V, f=1MHz		95		pF	
C _{rss}	Reverse Transfer Capacitance	7		18		pF	
R_q	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz		2.7	4	kΩ	
SWITCHI	NG PARAMETERS						
Q_g	Total Gate Charge			5.6	7.5	nC	
Q_{gs}	Gate Source Charge	V_{GS} = 4.5V, V_{DS} = 10V, I_{D} = 5A		0.85		nC	
Q_{gd}	Gate Drain Charge	1 1		1.7		nC	
t _{D(on)}	Turn-On DelayTime			172		ns	
t _r	Turn-On Rise Time	V_{GS} =10V, V_{DS} =10V, R_L =2.0 Ω ,		368		ns	
t _{D(off)}	Turn-Off DelayTime	$R_{GEN}=3\Omega$		2.94		บร	
t _f	Turn-Off Fall Time	1 1		2.5		บร	
t _{rr}	Body Diode Reverse Recovery Time	I _F =5A, dl/dt=100A/μs		32	43	ns	
Q_{rr}	Body Diode Reverse Recovery Charge	I _F =5A, dI/dt=100A/μs		3.2		nC	

A: The value of R $_{\theta JA}$ is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T $_A$ = 25°C. in any given application depends on the user's specific board design. The current rating is based on the t \leq 10s thermal resistance rating.

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B: Repetitive rating, pulse width limited by junction temperature.

C. The R $_{\theta JA}$ is the sum of the thermal impedence from junction to lead R $_{\theta JL}$ and lead to ambient.

D. The static characteristics in Figures 1 to 6 are obtained using < 300µs pulses, duty cycle 0.5% max.

E. These tests are performed with the device mounted on 1 in ² FR-4 board with 2oz. Copper, in a still air environment with T A=25°C. The SOA curve provides a single pulse rating.



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

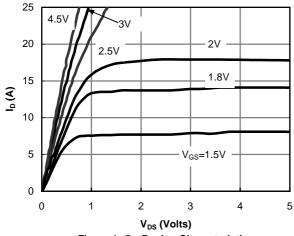


Figure 1: On-Region Characteristics

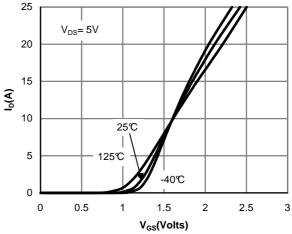


Figure 2: Transfer Characteristics

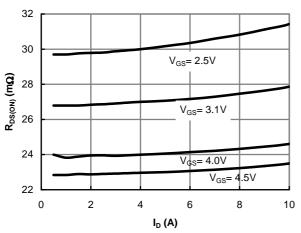


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

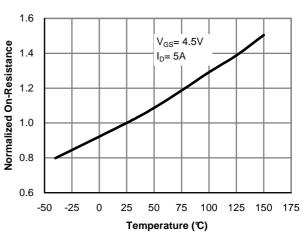


Figure 4: On-Resistance vs. Junction Temperature

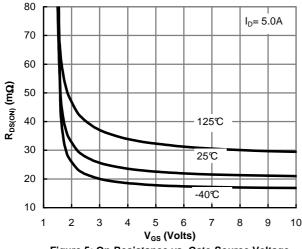


Figure 5: On-Resistance vs. Gate-Source Voltage

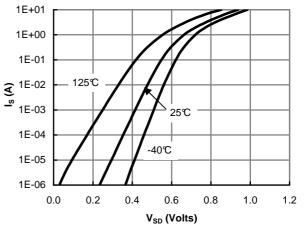
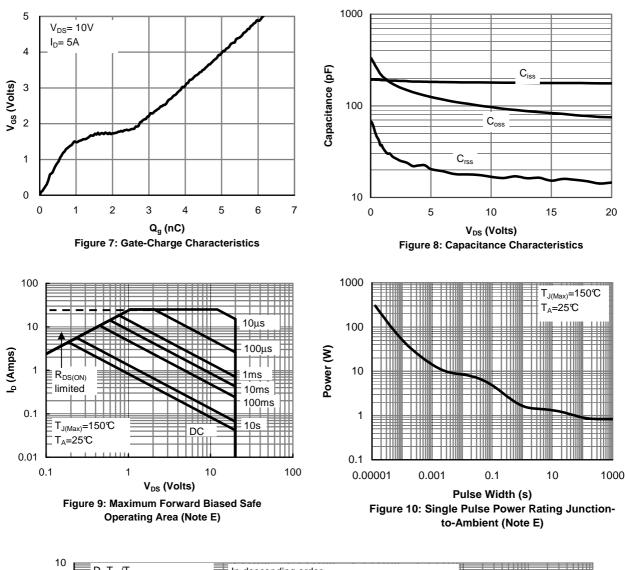


Figure 6: Body-Diode Characteristics



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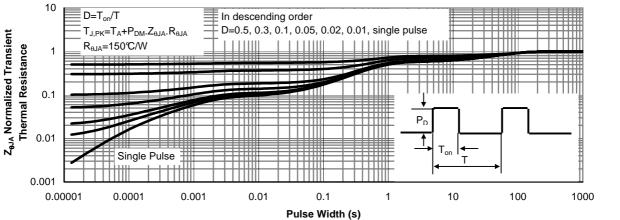
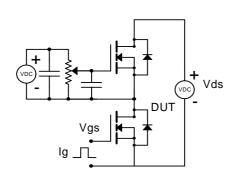


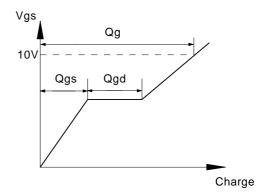
Figure 11: Normalized Maximum Transient Thermal Impedance(Note E)

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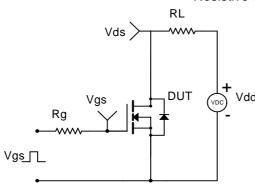


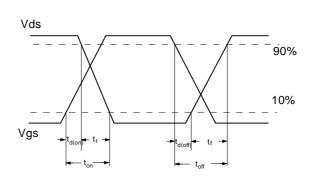
Gate Charge Test Circuit & Waveform





Resistive Switching Test Circuit & Waveforms





Diode Recovery Test Circuit & Waveforms

